STM32L071x8/B/Z
Errata sheet
STM32L071x8/B/Z device limitations

Silicon identification

This errata sheet applies to the revision A, B and Z of STMicroelectronics
STM32L071x8/B/Z microcontrollers.

The STM32L071x8/B/Z devices feature an ARM® 32-bit Cortex®-M0+ core.

The full list of part numbers is shown in Table 2. The products can be identified as shown in Table 1:
• by the revision code marked below the order code on the device package
• by the last three digits of the Internal order code printed on the box label

Table 1. Device identification(1)

<table>
<thead>
<tr>
<th>Order code</th>
<th>Revision code marked on device(2)</th>
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<tr>
<td>STM32L071x8/B/Z</td>
<td>“A” (engineering samples), “B” and “Z”</td>
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1. The REV_ID bits in the DBGMCU_IDCODE register show the revision code of the device (see the
STM32L0x2 reference manual for details on how to find the revision code).
2. Refer to the device datasheet for details on how to identify the revision code and the date code on the
different packages.

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1 ARM 32-bit Cortex-M0+ limitations

There are not limitations related to the ARM Cortex-M0+ core.
# STM32L071x8/B/Z silicon limitations

*Table 3* gives quick references to all documented limitations.

Legend for *Table 3*: A = workaround available; N = no workaround available; P = partial workaround available, ‘-’ and grayed = fixed.

## Table 3. Summary of silicon limitations

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### 2.1 System limitations

#### 2.1.1 Delay after an RCC peripheral clock enabling

**Description**

A delay between an RCC peripheral clock enable and the effective peripheral enabling should be taken into account in order to manage the peripheral read/write from/to registers.

This delay depends on the peripheral mapping:

- If the peripheral is mapped on AHB: the delay should be equal to 1 AHB clock cycle after the clock enable bit is set in the hardware register.
  
  For I/O peripheral, the delay should be equal to 1 AHB clock cycle after the clock enable bit is set in the hardware register (only applicable to write accesses).

- If the peripheral is mapped on APB: No delay is necessary (no limitation).
Workarounds

1. Enable the peripheral clock some time before the peripheral read/write register is required.
2. For AHB peripheral (including I/O), insert a dummy read operation to the corresponding register.

2.1.2 BFB2 bit does not select boot from Bank 2 system memory

Description

The feature which allows booting either from Bank 2 or from Bank 1 depending on BFB2 bit status (bit 23 in FLASH_OPTR register) does not work properly. When BFB2 user option bit is set, the code behavior after reset is incorrect.

Workaround

BFB2 user option bit must be kept at ‘0’. The user code stored in Bank 1 should jump to System memory if it requires a boot from Bank 2 and intends to benefit from bank swapping mechanism. Otherwise the code in Bank 1 can jump directly to Bank 2 when required.

Below a proposal of code that uses a value stored in EEPROM to define if the code to be executed is located in Bank 1 or 2. This code can be used in both banks and the EEPROM data must be the same in both EEPROM bank. This code shall be placed at the beginning of SystemInit() function:

```c
#define DATA_VALUE_SELECT 0x08080000 /* Location where to store the value allowing to boot on Bank2 and Bank1 */
#define DATA_BANK2_SELECTED 0x37 /* This value indicates that boot from Bank2 is required */
#define DATA_BANK1_SELECTED 0x73 /* This value indicates that boot from Bank1 is required */

/* Non user defines: these values must not be modified by user */
#define BANK2_START_ADDRESS_192KB 0x08018000 /* Bank 2 Start Address (192KB) */
#define BANK2_START_ADDRESS_128KB 0x08010000 /* Bank 2 Start Address (128KB) */
#define FLASH_START_ADDRESS    0x08000000 /* Flash Start Address (Bank1) */
#define ENGI_SALESTYPE_ADDRESS 0x1FF80034
#define ENGI_SALESTYPE_MASK    0x00000C00
#define ENGI_SALESTYPE_192KB   0x00000000
#define ENGI_SALESTYPE_128K    0x00000400
#define ENGI_SALESTYPE_64K     0x00000C00
#define SALESTYPE_192KB_DB     0x11001100
#define SALESTYPE_128K_DB      0x22002200
#define SALESTYPE_64K_SB       0x33003300
#define SYSCFG_MEMRMP_ADDRESS  0x40010000
```
#define SYSCFG_MEMMODE_MASK        0x00000003
#define SYSCFG_MEMMODE_SYSMEM      0x00000001
#define SYSCFG_FBMODE_MASK         0x00000008

void SystemInit (void)
{
    void (*start_of_bootloader)(void);
    start_of_bootloader = (void(*)(void))*(unsigned int*)0x1FF00004; /*
0x1FF00004 is the reset vector of the system flash*/

    /* Check what is the device salestype (192KB, 128KB or 64KB) */
    if  (((*(__IO uint32_t *) (ENGI_SALESTYPE_ADDRESS)) & ENGI_SALESTYPE_MASK) == ENGI_SALESTYPE_192KB)
    {
        /* If 192KB salestype */
        SalesType = SALESTYPE_192KB_DB;
    }
    else if (( (*(__IO uint32_t *) (ENGI_SALESTYPE_ADDRESS)) & ENGI_SALESTYPE_MASK) == ENGI_SALESTYPE_128K)
    {
        /* If 128KB salestype */
        SalesType = SALESTYPE_128K_DB;
    }
    else
    {
        /* If 64KB salestype */
        SalesType = SALESTYPE_64K_SB;
    }

    /* Enable the SYSCFG APB Clock */
    *((__IO uint32_t *) 0x40021034 |= ((uint32_t)0x00000001);

    /******************************************************************************
    Get salestype  ***************************************************************************/

    /* Manage case when single bank salestypes are used */
    if (SalesType !=  SALESTYPE_64K_SB)
    {
        /* Get bank2 start address depending on the package */
        Bank2Addr = (SalesType ==  SALESTYPE_192KB_DB)? BANK2_START_ADDRESS_192KB : BANK2_START_ADDRESS_128KB;

        if (((SYSCFG->CFGR1 & SYSCFG_FBMODE_MASK) ==0))
        {
            /* we are in bank1*/
            /******************************************************************************/
            /* Check Data value ******************************************************************************/

            /******************************************************************************/
        }
    }
if (*(unsigned int*)Bank2Addr>0x20000000 && *(unsigned int*)Bank2Addr<=0x20005004 ) {
    start_of_bootloader();
}

2.1.3 Interrupts masked when using dual-bank boot mechanism

Description
When the dual-bank boot mechanism is used, either by setting BFB2 bit in FLASH_OPTR register or by using the workaround described in Section 2.1.2, the microcontroller starts executing the user code with bit 0 of the core Priority Mask register (PRIMASK) set. As a result, the interrupts are not serviced.

Workaround
Set bit 0 of PRIMASK register before activating any interrupt. See code below as an example:

```
__ASM ("CPSIE i");
```

2.1.4 PE2 AF2 alternate function (TIM3_ETR) not available

Description
When PE2 is configured as an alternate function 2 (AF2) to receive TIM3_ETR, incoming data can be corrupted due to the fact that the output logic of the same PAD is not properly disabled.

Workaround
Use another GPIO (PD2 AF2) for TIM3_ETR

2.1.5 PB4 not available on UFQFPN32 package

Description
PB4 GPIO does not exist on UFQFPN32 package. As a result, PB4 cannot be used.

Workaround
None.
2.1.6  Flash memory wakeup issue when waking up from Stop or Sleep with Flash in power-down mode

Description
When an external wake-up event (EXTI) occurs in a narrow time window around low-power mode entry (Stop or Sleep mode with Flash memory in power-down state), the Flash wakeup time may be increased. As a result, the first data read or instruction fetch from Flash may be incorrect.

The probability that this issue occurs is very low since it may happen only during a very narrow time window.

Workaround
Three workarounds are available:
- Do not put the Flash memory module in power-down mode when entering Sleep or Low-power sleep modes.
- Before entering Stop mode by executing a WFI instruction from RAM, set the RUN_PD bit in the FLASH_ACR register. After exiting from Stop mode, the Flash memory is automatically powered ON and you can resume program execution from Flash memory. After wakeup, clear the RUN_PD bit.
- Before entering Stop mode by executing WFI instruction from RAM, set the RUN_PD bit in the FLASH_ACR register and set the DS_EE_KOFF bit in PWR_CR register. After resuming from STOP mode, the Flash memory stays in power-down mode. Wake-up the Flash memory by clearing FLASH_ACR_RUN_PD bit and return to code execution.

2.1.7  Unexpected system reset when waking up from Stop mode with regulator in low-power mode

Description
When the device returns to Run mode after waking up from Stop mode while the internal voltage regulator is configured to switch to low-power mode in Stop mode (LPSDSR=1 in PWR_CR register), an unexpected system reset may occur if the following conditions are met:
- The internal regulator is set to Range 2 or Range 3 before entering Stop mode.
- VDD power supply is below 2.7 V.

The probability that this issue occurs is very low since it may happen only for very narrow supply voltage windows which vary from one device to another.

This reset is internal only and does not affect the NRST pin state and the flags in the Control/status register (RCC_CSR).

Workaround
Two workarounds are possible:
- Enter Stop mode with the internal voltage regulator set to main mode (LPSDSR=0 in PWR_CR).
- Set the internal voltage regulator to Range1 before entering Stop mode.
2.1.8 Electrical sensitivity characteristics

Description
The ESD Absolute maximum ratings are lower compared to some other STM32 devices:
- Electrostatic discharge voltage human body model \( V_{\text{ESD(HBM)}} \) class is 1C instead of 2 and the maximum value is 1000 V instead of 2000 V.
- Electrostatic discharge voltage charge device model \( V_{\text{ESD(CDM)}} \) class is C3 and the maximum value is 250 V instead of 500 V.

Workaround
None.

2.1.9 I2C and USART cannot wake up the device from Stop mode

Description
When the microcontroller is in Stop mode with the regulator in low-power mode, an unexpected system reset may occur if the I2C or the USART attempts to wake up the device.

This limitation also impacts LPUART when the HSI16 is used as clock source instead of LSE.

This reset is internal only and does not affect the NRST pin state and the flags in the Control/status register (RCC_CSR).

The lower the \( V_{\text{DD}} \) value, the more often this unpredictable behavior may occur.

Workaround
No workaround is available.

It is recommended to avoid using the USART and I2C wakeup from Stop mode features. To disable them, keep WUPEN bit in I2C_CR1 and UESM bit in USARTx_CR1 at '0'.

Two solutions are then possible to perform I2C or USART communications:
- Put the microcontroller in a mode different from Stop (or Standby mode) before initiating communications.
- Replace Stop mode with Stop mode plus regulator in main mode by keeping LPSDSR bit of PWR_CR set to '0'.

2.1.10 LDM, STM, PUSH and POP not allowed in IOPORT bus

Description
The instructions Load Multiple (LM), Store Multiple (STM), PUSH and POP fail when the address points to the IOPORT bus memory area (address range = 0x5XXX XXXX).

Workaround
None.
2.1.11 BOOT_MODE bits do not reflect the selected boot mode

Description
The BOOT_MODE[1:0] bits of the SYSCFG_CFGR1 register remain set to ‘0’ while they should reflect the boot mode selected by the boot pins.

Workaround
None.

2.2 Comparator limitations

2.2.1 COMP1_CSR and COMP2_CSR lock bit reset by SYSCFGRST bit in RCC_APB2RSTR register

Description
When the SYSCFGRST bit of RCC_APB2RSTR register is set, the COMP1_CSR and COMP2_CSR register contents are reset even if COMP1LOCK and COMP2LOCK bits are set in COMP1_CSR and the COMP2_CSR register, respectively.

Workaround
No workaround is available.

For security reasons, it is recommended to avoid using SYSCFGRST bit of RCC_APB2RSTR when COMP1LOCK and/or COMP2LOCK bits are set.

2.2.2 Output of comparator 2 cannot be internally connected to input 1 of low-power timer

Description
The COMP2LPTIMIN1 bit (bit 13 of COMP2_CSR register) which internally connects COMP2VALUE to the low-power timer (LPTIM) input 1 has no effect.

Workaround
Connect COMP2_OUT output to an external pin and configure LPTIM_IN1 on an external pin, then connect both pins together externally.

2.3 RTC limitations

2.3.1 Spurious tamper detection when disabling the tamper channel

Description
If the tamper detection is configured for detection on falling edge event (TAMPFLT=00 and TAMPxTRG=1) and if the tamper event detection is disabled when the tamper pin is at high level, a false tamper event is detected.
2.3.2 Detection of a tamper event occurring before enabling the tamper detection is not supported in edge detection mode

**Description**

When the tamper detection is enabled in edge detection mode (TAMPFLT=00):

- When TAMPxTRG=0 (rising edge detection): if the tamper input is already high before enabling the tamper detection, the tamper event may or may not be detected when enabling the tamper detection. The probability to detect it increases with the APB frequency.
- When TAMPxTRG=1 (falling edge detection): if the tamper input is already low before enabling the tamper detection, the tamper event is not detected when enabling the tamper detection.

**Workaround**

The I/O state should be checked by software in the GPIO registers, just after enabling the tamper detection and before writing sensitive values in the backup registers, in order to ensure that no active edge occurred before enabling the tamper event detection.

2.4 I2C peripheral limitations

2.4.1 Wrong behaviors in Stop mode when waking up from Stop mode is disabled in I2C peripheral

**Description**

When wakeup from Stop mode is disabled in the I2C interface (WUPEN = 0) and the microcontroller enters Stop mode while a transfer is ongoing on the bus, some wrong behavior may happen:

1. The BUSY flag can be wrongly set when the microcontroller exits Stop mode. This prevents from initiating a transfer in master mode, as the START condition cannot be sent when BUSY is set.
2. If clock stretching is enabled (NOSTRETCH = 0), the I2C clock SCL may be kept low by the I2C as long as the microcontroller remains in Stop mode. This limitation may occur when Stop mode is entered during the address phase of a I2C bus transfer while SCL = 0. Therefore the transfer may be stalled as long as the microcontroller is in Stop mode. The probability that this issue occurs depends also on the timings configuration, the peripheral clock frequency and the I2C bus frequency.

These behaviors can occur in Slave mode and in Master mode in a multi-master topology.

**Workaround**

Disable the I2C interface (PE=0) before entering Stop mode and enable it again in Run mode.
2.4.2 Wrong data sampling when data set-up time ($t_{SU;DAT}$) is smaller than one I2CCLK period

Description

The I2C bus specification and user manual specifies a minimum data set-up time ($t_{SU;DAT}$) at:

- 250 ns in Standard-mode,
- 100 ns in Fast-mode,
- 50 ns in Fast-mode Plus.

The I2C SDA line is not correctly sampled when $t_{SU;DAT}$ is smaller than one I2CCLK (I2C clock) period: the previous SDA value is sampled instead of the current one. This can result in a wrong slave address reception, a wrong received data byte, or a wrong received acknowledge bit.

Workaround

Increase the I2CCLK frequency to get I2CCLK period smaller than the transmitter minimum data set-up time. Or, if it is possible, increase the transmitter minimum data set-up time.

2.5 SPI/I2S peripheral limitations

2.5.1 In I2S slave mode, WS level must to be set by the external master when enabling the I2S peripheral

Description

In slave mode, the WS signal level is used only to start communications. If the I2S (in slave mode) is enabled while the master is already sending the clock, and the WS signal level is either low (for I2S protocol) or high (for the LSB or MSB-justified mode), the slave starts communicating data immediately. In this case the master and slave will be desynchronized throughout the whole communication.

Workaround

Enable the I2S peripheral when the external master sets the WS line at:

- High level when the I2S protocol is selected.
- Low level when the LSB or MSB-justified mode is selected.
2.5.2 BSY bit may stay high at the end of a SPI data transfer in slave mode

Description

In slave mode, BSY bit is not reliable to handle the end of data frame transaction due to some bad synchronization between the CPU clock and external SCK clock provided by master. Sporadically, the BSY bit is not cleared at the end of a data frame transfer. As a consequence, it is not recommended to rely on BSY bit before entering low-power mode or modifying the SPI configuration (e.g. direction of the bidirectional mode).

Workaround

- When the SPI interface is in receive mode, the end of a transaction with the master can be detected by the corresponding RXNE event when this flag is set after the last bit of that transaction is sampled and the received data are stored.
- When the following sequence is used, the synchronization issue does not occur. The BSY bit works correctly and can be used to recognize the end of any transmission transaction (including when RXNE is not raised in bidirectional mode):
  a) Write the last data into data register.
  b) Poll TXE flag till it becomes high to make sure the data transfer has started.
  c) Disable the SPI interface by clearing SPE bit while the last data transfer is ongoing.
  d) Poll the BSY bit till it becomes low.

Note: The second workaround can be used only when the CPU is fast enough to disable the SPI interface after a TXE event is detected while the data frame transfer is ongoing. It cannot be implemented when the ratio between CPU and SPI clock is low and the data frame is particularly short. At this specific case, the timeout can be measured from the TXE event instead by calculating a fixed number of CPU clock cycles corresponding to the time necessary to complete the data frame transaction.

2.5.3 Last data bit or CRC calculation may be corrupted for the data received in master mode depending on the feedback communication clock timing with respect to the APB clock (SPI or I2S)

Description

When the SPI or I2S interface is configured in master mode, the last transacted bit of the received data may be corrupted if the delay of the internal feedback clock, which is derived from SCK pin, is higher than the APB clock period. In this case, the last bit value is strobed too late into the shift register while its content has already been either copied to the data register or compared to the pattern calculated internally.

When data corruption occurs, the bit position in the data register contains the value of the last bit received during the previous data transfer or the CRC error flag (CRCERR) is asserted in spite of the fact that all data have been correctly received.

This limitation may be observed only when the device is configured in SPI or I2S is master (full-duplex or receiver mode).
The main factors which can increase the above delay, and the risk that this issue occurs, are:

- High external SPI clock capacitive load
- Low SCK I/O output speed
- Low $V_{DD}$ level
- Extreme temperature

*Note:* SPI communication speed has no impact.

**Workaround**

Set the I/O pad configuration to achieve a faster I/O output speed on SCK pin, regardless the SPI speed. Max SCK line capacitance must be limited below 30pF.

### 2.5.4 Limited SPI frequency when peripheral configured in Master reception or in Slave transmission mode and $V_{DD}$ is below 2.7 V

**Description**

When the SPI is configured in Master reception or in Slave transmission mode, the maximum SPI frequency should be 16 MHz in Range1 ($V_{DD}$ ranging from 1.71 to 3.6 V). However a timing issue limits the maximum transaction reachable frequency when $V_{DD}$ is below 2.7 V.

**Workaround**

None.

### 2.6 USART limitations

#### 2.6.1 Start bit detected too soon when sampling for NACK signal from the smartcard

**Description**

According to ISO/IEC 7816-3 standard, when a character parity error is incorrect, the smartcard receiver shall transmit a NACK error signal $10.5 \pm 0.2$ ETUs after the character START bit falling edge. In this case, the USART transmitter should be able to detect correctly the NACK signal by sampling at $11 \pm 0.2$ ETUs after the character START bit falling edge.

In Smartcard mode, the USART peripheral does not respect the $11 \pm 0.2$ ETU timing. As a result, when the NACK falling edge occurs $10.68$ ETUs or later, the USART may misinterpret this transition as a START bit even if the NACK is correctly detected.

**Workaround**

None
2.6.2 Break request can prevent the Transmission Complete flag (TC) from being set

Description
After the end of transmission of a data (D1), the Transmission Complete (TC) flag will not be set if the following conditions are met:
- CTS hardware flow control is enabled.
- D1 is being transmitted.
- A break transfer is requested before the end of D1 transfer.
- nCTS is deasserted before the end of D1 data transfer.

Workaround
If the application needs to detect the end of a data transfer, the break request should be issued after checking that the TC flag is set.

2.6.3 nRTS is active while RE or UE = 0

Description
The nRTS line is driven low as soon as the RTSE bit is set and even if the USART is disabled (UE = 0) or if the receiver is disabled (RE=0) i.e. not ready to receive data.

Workaround
Configure the I/O used for nRTS as an alternate function after setting the UE and RE bits.
# Revision history

## Table 4. Document revision history

<table>
<thead>
<tr>
<th>Date</th>
<th>Revision</th>
<th>Changes</th>
</tr>
</thead>
<tbody>
<tr>
<td>02-Jul-2015</td>
<td>1</td>
<td>Initial release.</td>
</tr>
<tr>
<td>14-Oct-2014</td>
<td>2</td>
<td>Changed confidentiality level to public. Added STM32L071C8 on cover page. Updated Section 2.1.2: BFB2 bit does not select boot from Bank 2 system memory and added Section 2.1.3: Interrupts masked when using dual-bank boot mechanism. Added Section 2.1.9: I2C and USART cannot wake up the device from Stop mode and Section 2.1.10: LDM, STM, PUSH and POP not allowed in IOPORT bus</td>
</tr>
<tr>
<td>05-Feb-2016</td>
<td>3</td>
<td>The following limitations are fixed in device revision Z: – BFB2 bit does not select boot from Bank 2 system memory – I2C and USART cannot wake up the device from Stop mode – BOOT_MODE bits do not reflect the selected boot mode (this limitation has been added in current errata sheet revision). Added Section 2.2.1: COMP1_CSR and COMP2_CSR lock bit reset by SYSCFG_RST bit in RCC_APB2RSTR register. Updated Section 2.5.3: Last data bit or CRC calculation may be corrupted for the data received in master mode depending on the feedback communication clock timing with respect to the APB clock (SPI or I2S).</td>
</tr>
</tbody>
</table>
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